



US00D666601S

(12) **United States Design Patent**  
**Li**

(10) **Patent No.:** **US D666,601 S**  
(45) **Date of Patent:** **\*\* Sep. 4, 2012**

(54) **COVER OF AN ELECTRONIC DEVICE  
HAVING SURFACE ORNAMENTATION**

(75) Inventor: **Bin Li**, Shenzhen (CN)

(73) Assignee: **FIH (Hong Kong) Limited**, Kowloon  
(HK)

(\*\*) Term: **14 Years**

(21) Appl. No.: **29/415,635**

(22) Filed: **Mar. 13, 2012**

(51) **LOC (9) Cl.** ..... **14-03**

(52) **U.S. Cl.** ..... **D14/248**

(58) **Field of Classification Search** ..... D14/248,  
D14/138 R, 138 AA, 138 AB, 138 AC, 138 AD,  
D14/138 C, 138 G, 203.7, 341-347, 250,  
D14/440, 140, 240, 251-253, 439, 299, 238.1,  
D14/217, 218, 168-169, 172, 496, 247, 203;  
D3/248, 201, 218, 269, 273, 301, 303; D21/458;  
455/575.1, 575.3, 575.4, 575.8, 556.1, 556.2;  
D25/103, 110, 111, 117, 118, 145, 154, 155,  
D25/156, 157, 158; D5/2, 3, 4, 7, 19, 23,  
D5/24, 32, 36, 39, 46, 48, 55, 56, 66, 99,  
D5/37-38, 41, 58-63, 1, 47, 26, 20, 57, 53,  
D5/12, 17, 11, 49, 5, 8, 27, 64, 65; D13/103,  
D13/108, 107; D6/595, 596, 601, 602, 603,  
D6/610, 611, 612, 616, 617, 621, 622, 615;  
D11/22, 96, 131, 132, 140, 200, 207, 210,  
D11/212-214, 222, 226-228, 235-237; D32/40;  
D12/213; 15/215; 428/30, 604

See application file for complete search history.

(56) **References Cited**

**U.S. PATENT DOCUMENTS**

D60,411 S \* 2/1922 Humphreys ..... D5/60  
(Continued)

**FOREIGN PATENT DOCUMENTS**

WO DM/072569 \* 8/2009

**OTHER PUBLICATIONS**

Christian Dior Luxury Phone, posted on Jan. 3, 2011, URL:<http://www.technology-guide.co.uk/post/2011/01/03/Hi-Fashion-Luxury-Mobile-Phones-From-the-House-of-Dior.aspx>>, retrieved from internet on Apr. 22, 2012.\*

(Continued)

*Primary Examiner* — Carla Wright

(74) *Attorney, Agent, or Firm* — Altis Law Group, Inc.

(57) **CLAIM**

The ornamental design for a cover of an electronic device having surface ornamentation, as shown and described.

**DESCRIPTION**

The present application is related to copending U.S. patent applications Ser. Nos. 29/415,338, 29/415,537, 29/415,532, 29/415,534, 29/415,340, 29/415,530, 29/415,529, 29/415,528, 29/415,526, 29/415,524, 29/415,523, 29/415,521, 29/415,634, 29/415,633, 29/415,520, 29/415,632, 29/415,631, 29/415,629, 29/415,628, 29/415,630, and 29/415,636, each entitled "Cover of an Electronic Device Having Surface Ornamentation", by Bin Li. These applications have the same assignee as the present application and have been concurrently filed herewith. The above-identified applications are incorporated herein by reference.

FIG. 1 is a perspective view of a cover of an electronic device having surface ornamentation showing my new design;

FIG. 2 is a front elevational view thereof;

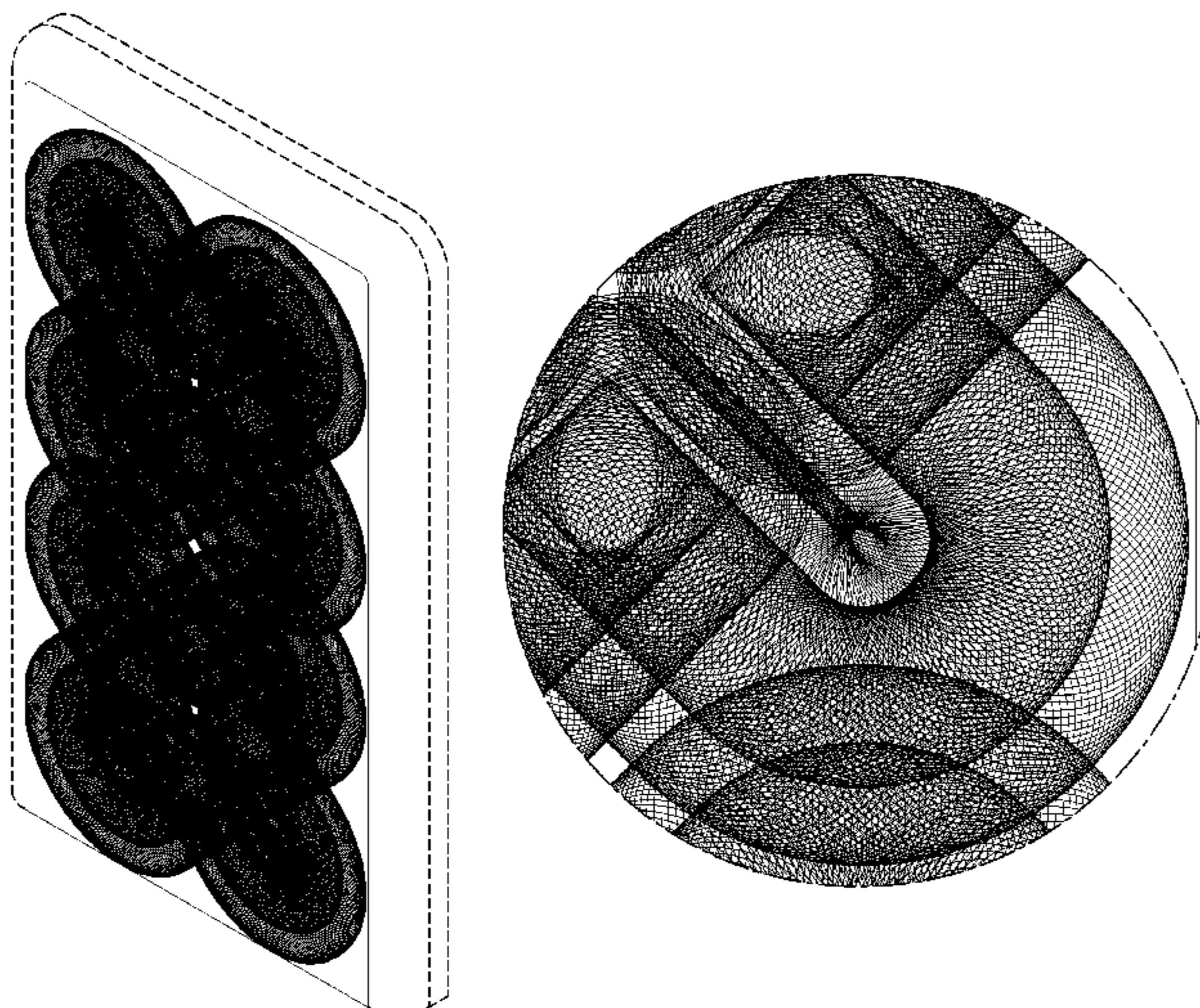
FIG. 3 is a side elevational view thereof; and,

FIG. 4 is an enlarged fragmentary view thereof showing circled portion 4 in FIG. 2.

In FIGS. 1-3, the evenly segmented broken lines indicate portions of the cover of an electronic device having surface ornamentation that form no part of the claimed design. In FIGS. 2 and 4, the unevenly segmented broken lines indicate the portion of the cover of an electronic device having surface ornamentation that is shown on an enlarged scale in FIG. 4.

The broken lines form no part of the claimed design.

**1 Claim, 4 Drawing Sheets**



# US D666,601 S

Page 2

## U.S. PATENT DOCUMENTS

D73,654 S \* 10/1927 Finlay ..... D5/59  
D121,050 S \* 6/1940 Robinson ..... D5/59  
D159,208 S \* 7/1950 Hyman ..... D25/158  
2,529,945 A \* 11/1950 Hyman ..... 428/156  
D191,660 S \* 10/1961 Smith ..... D25/154  
D216,933 S \* 3/1970 Hicks ..... D5/59  
D358,149 S \* 5/1995 Fellingner ..... D14/138 AB  
D419,777 S \* 2/2000 Ale' et al. .... D5/7  
D488,452 S \* 4/2004 Chung ..... D14/138 AB  
D489,186 S \* 5/2004 McMahan ..... D5/26  
6,932,007 B1 \* 8/2005 Beauchamp ..... 112/117  
D539,259 S \* 3/2007 Wang et al. .... D14/138 AA  
D546,346 S \* 7/2007 Miyamori et al. .... D14/496  
7,337,565 B2 \* 3/2008 Tsutsumi et al. .... 40/451

D565,597 S \* 4/2008 Kim ..... D14/496  
D602,894 S \* 10/2009 Lepoultier et al. .... D14/138 AB  
D613,278 S \* 4/2010 Chu et al. .... D14/248  
D616,427 S \* 5/2010 Li ..... D14/247  
D647,085 S \* 10/2011 Chung et al. .... D14/250  
D654,902 S \* 2/2012 Chung ..... D14/138 AD

## OTHER PUBLICATIONS

Laser Engraving Cell Phone Case for iPhone 4/4s from Shenzhen JingXinQi Electronic Co. Ltd., <URL:<http://wenwendove.en.made-in-china.com/product/PelmSVnDYXRH/China-Laser-Engraving-Cell-Phone-Case-for-iPhone-4-4s.html>>, retrieved from internet on May 5, 2012.\*

\* cited by examiner



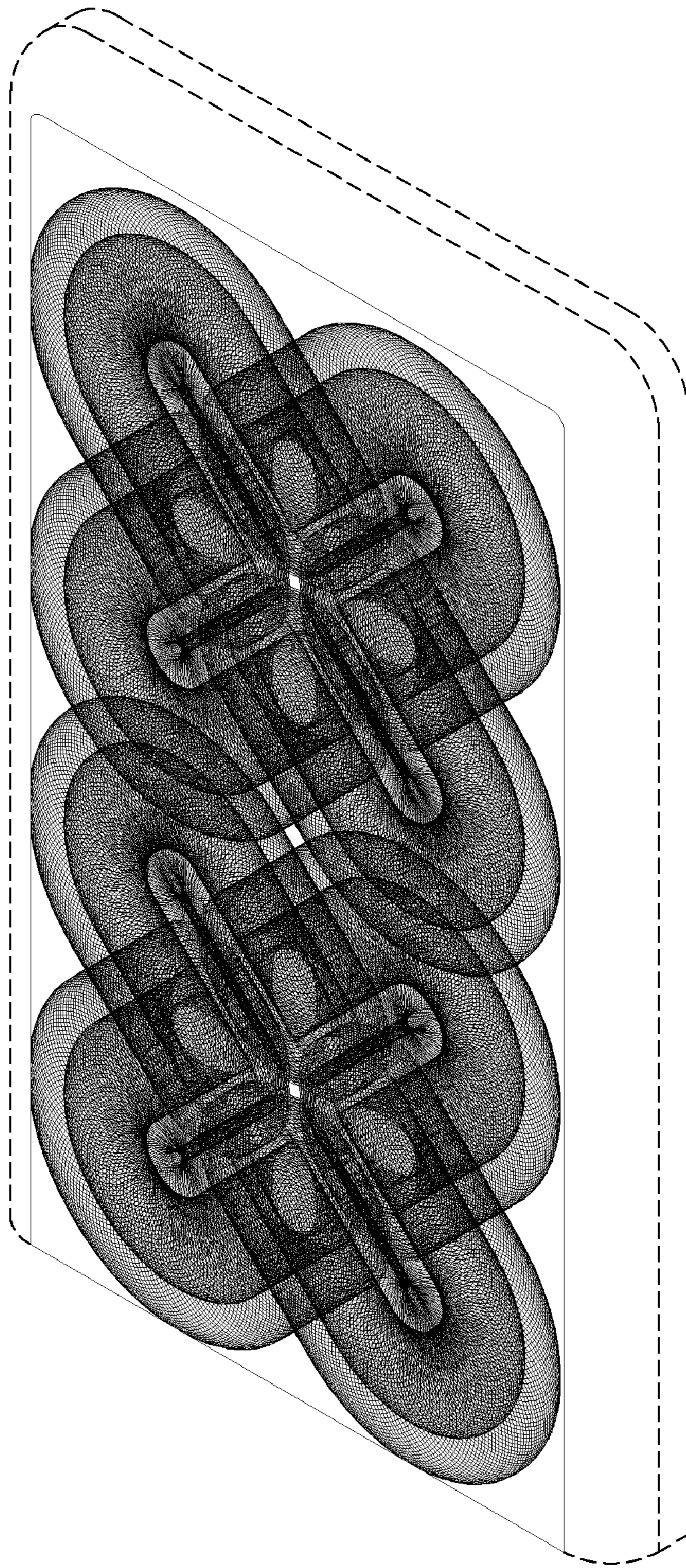


FIG. 1



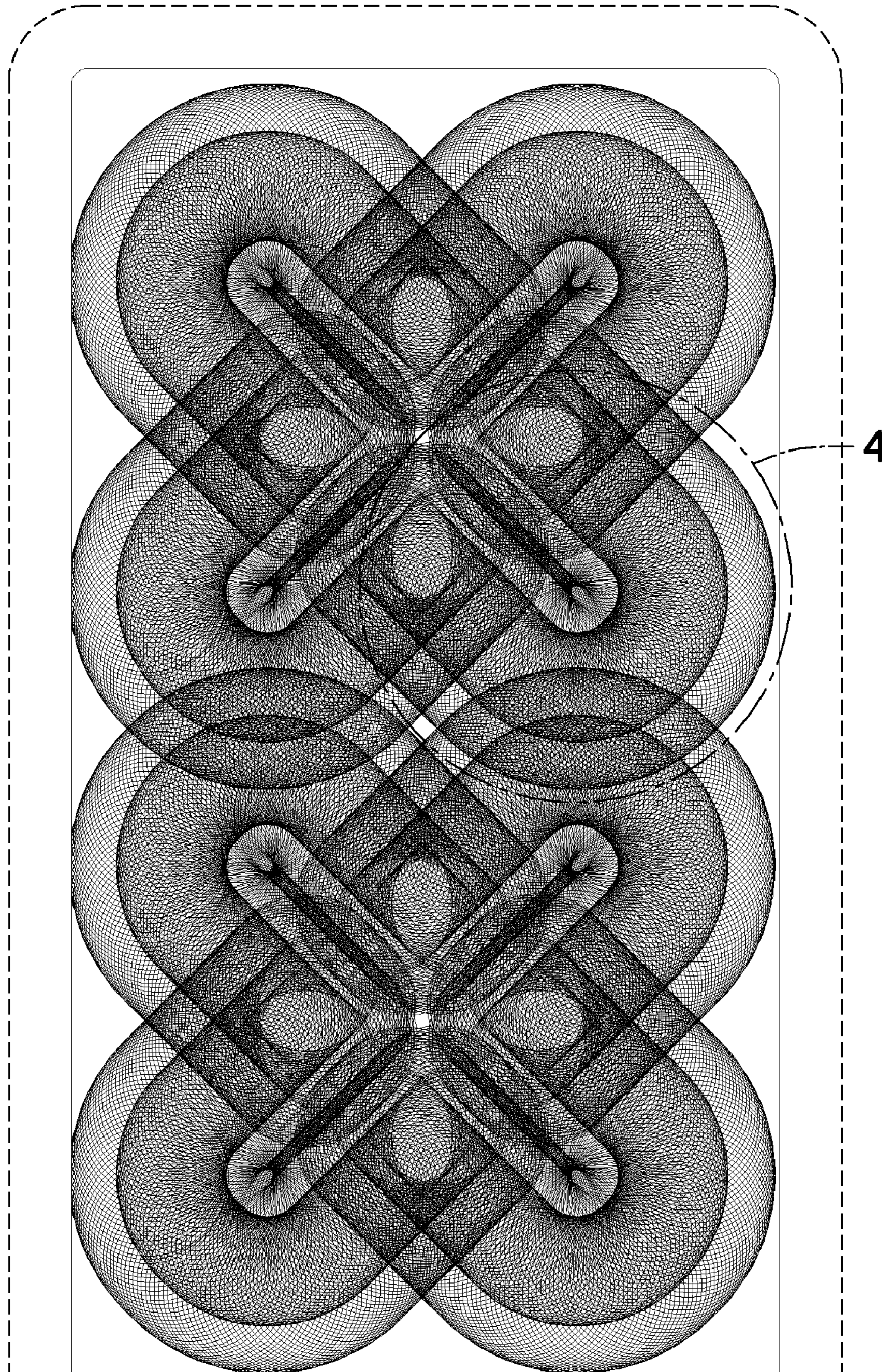


FIG. 2



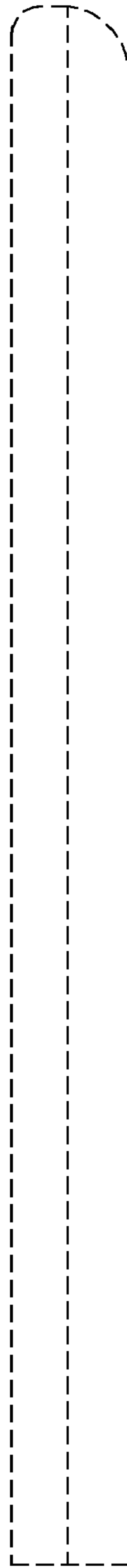


FIG. 3



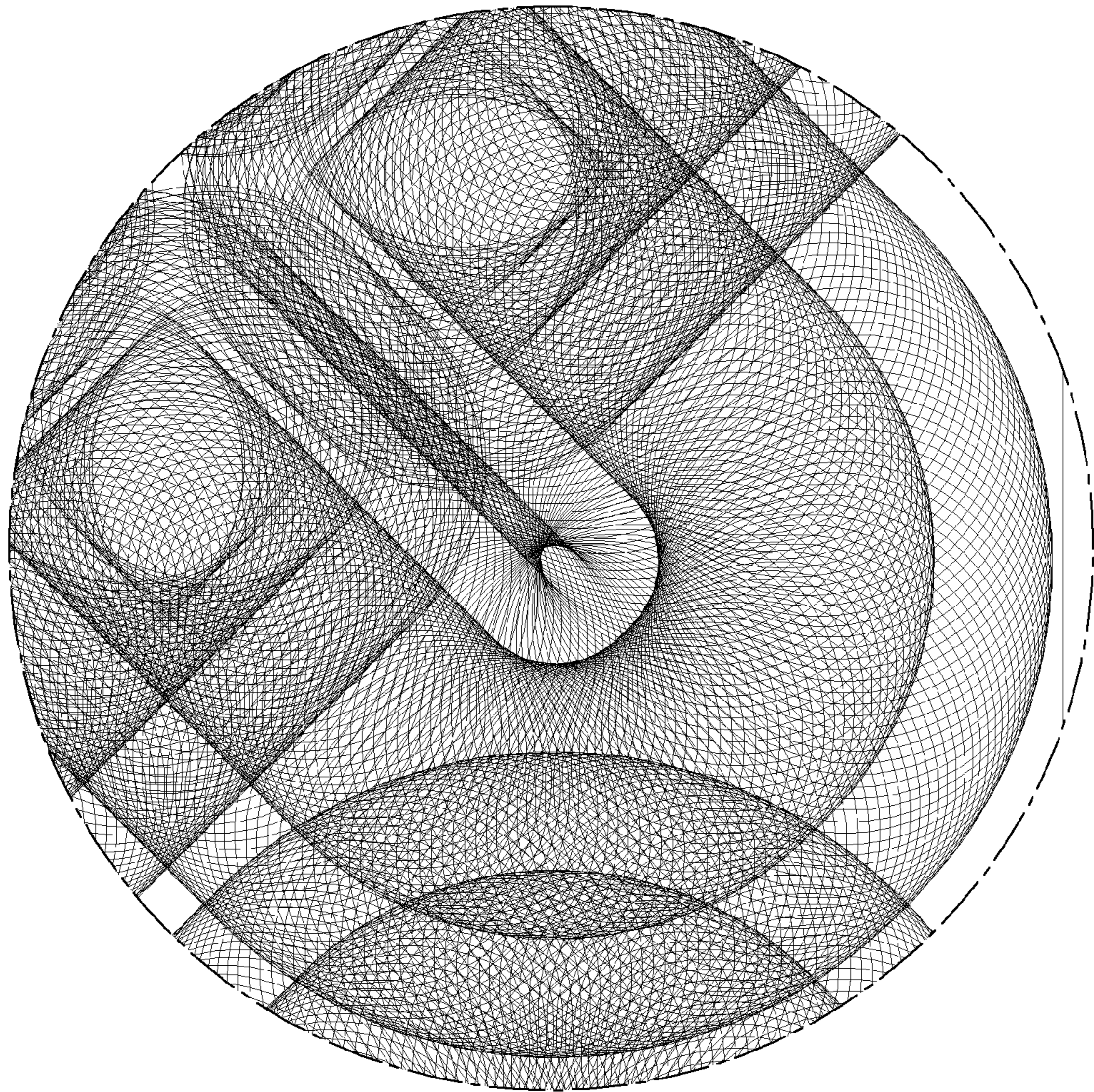


FIG. 4